



Technical Data

PHOTOCAP[®] 35530P

PHOTOCAP® 35530P is an ultra fast cure and PID resistant POE (polyolefin elastomer) photovoltaic encapsulating film.

PHOTOCAP 33530P can be used for all photovoltaic module constructions, including thin film photovoltaic designs. PHOTOCAP 35520P is provided as rolled film ready for use in thermal lamination processes. The material is self-priming for adhesion to glass and crosslinkable for improved mechanical properties and light transmission compared to pure thermoplastic POEs. The same process equipment and conditions used for other ultra-fast cure PHOTOCAP EVA encapsulant can be used for this product.

Properties	Test Method ASTM	Units	Condition	Results
Physical Mechanical	AGTIM			
Tensile Strength	D638	MPa	23 ℃, 250 mm/min elongation rate	15
Ultimate Elongation	D638	%	23 ℃, 250 mm/min elongation rate	700
10% Secant Modulus	D638	MPa	23 ℃, 250 mm/min elongation rate	26
Adhesion to Glass	STR	N/cm	23℃	130
MVTR	F1249	g/m²/day	25 ℃/100sccm flow, 100%RH	5
Water Absorption	D570	wt%	23℃	< 0.1
Optical				
Optical Transmission	E424	%	23 ℃, 0.46 mm thickness	91
UV Cutoff Wavelength	E424	nm	23 ℃, 0.46 mm thickness	360
Refractive Index	D542	-	23℃, 0.46 mm thickness	1.48
Electrical				
Volume Resistivity	D257	ohm cm	23 °C/50%RH	>1 x 10 ¹⁶
Dielectric Strength	D149	kV/mm	23°C/50% RH, 500V/sec	>20

Tests are made in accordance with the current issue of the ASTM, or other cited test method. Test data reported here are nominal values measured on extruded films, 0.5 mm thick, or compression molded sheets and test bars, which have been cured at 150 °C for 7 minutes with a laboratory press. Optical measurements made with glass-POE coupons with high transmission solar glass.

STR Locations

Email: <u>sales@STRSolar.com</u> Tel: 1 860 272 4235 STR – United States of America 10 Water Street Enfield, CT. USA 06082

STR - Spain Parque Tech de Asturias, Parcela 36 Llanera, Asturias, España 33428 STR – Malaysia Plot D20, Jalan Tanjung A/3 Port of Tanjung Pelepas Gelang Patah, Johor, Malaysia 81560

STR – China Changkun Ind. Park No.26 Nanxin Road, Sha Jiabang Changshu, Suzhou, China 215542

WWW.STRSOLAR.COM





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AGENCY APPROVALS:

PHOTOCAP 35530P is in the process of being UL listed in category QIHE2 Photovoltaic Polymeric Materials. Please refer to UL file number E310488.

PRODUCT VARIATIONS:

Suffix	Release Paper	Shrinkage	Notes
35530P/UFP	No	Minimal	Paperless UF option, resulting in minimal shrinkage
35530P/PL	No	Higher than UF or UFP	Possesses a greater tendency to shrink but perfectly acceptable for use in most applications

PROCESS GUIDELINES:

Vacuum Lamination Step		Heat Cure Cycle		
Nominal Temperature	150 <i>°</i> C	Platen Temperature	150 <i>°</i> C	
Vacuum Range	< 60 mbar	Cure Time	10 min	
Evacuation Time	5 min	Applied Bladder Pressure	910 mbar	
POE Melting Range Via DSC	80 - 90 ℃	Target Temperature within the Encapsulant	140 <i>℃</i>	
		Time Above the Target Temperature	> 5 min	

Processing conditions shown here are a recommended starting point for a crystalline silicon photovoltaic module processed with a typical 2-step vacuum lamination system. Actual values required to achieve desired cure levels will depend on the specific PV module design and the lamination process used.

The temperature of the encapsulant should be at or above the POE melting range before pressure is applied for the cure cycle. The encapsulant should reach the target temperature during the cure cycle, and should remain above that target temperature for the time shown. Temperatures within encapsulant should be periodically measured with embedded thermocouples to assess temperature uniformity of the laminator heating plate and the rate of heat transfer to the PV module. More information about how to laminate PV modules with PHOTOCAP encapsulants is available from STR.

All PHOTOCAP grades are based upon over 30 years of STR's commercial experience in the photovoltaic market.

For further information, please contact the nearest Specialized Technology Resources office or agent.

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